

30 A, 600 V ultra fast IGBT

## Features

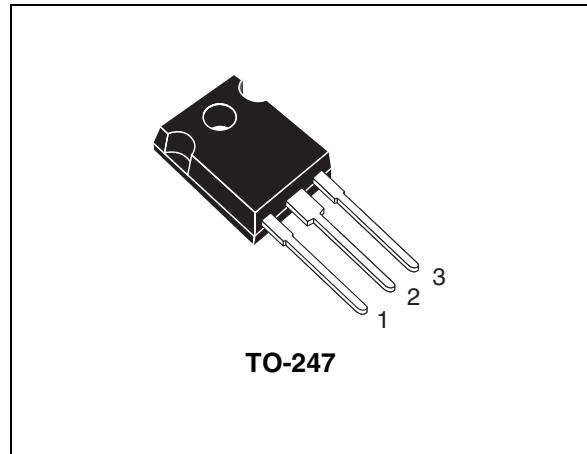
- High frequency operation
- Lower  $C_{RES}$  /  $C_{IES}$  ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode

## Applications

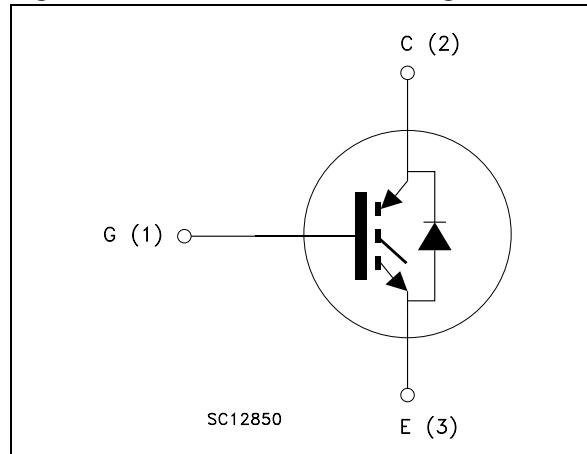
- High frequency motor controls, inverters, UPS
- HF, SMPS and PFC in both hard switch and resonant topologies

## Description

This IGBT utilizes the advanced Power MESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.



**Figure 1. Internal schematic diagram**



**Table 1. Device summary**

Order code	Marking	Package	Packaging
STGW30NC60WD	GW30NC60WD	TO-247	Tube

## Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CES}$	Collector-emitter voltage ( $V_{GE} = 0$ )	600	V
$I_C^{(1)}$	Collector current (continuous) at 25 °C	60	A
$I_C^{(1)}$	Collector current (continuous) at 100 °C	30	A
$I_{CP}^{(2)}$	Collector current (pulsed)	150	A
$I_{CL}^{(3)}$	Turn-off latching current	150	A
$V_{GE}$	Gate-emitter voltage	± 20	V
$I_F$	Diode RMS forward current at $T_C = 25$ °C	30	A
$I_{FSM}$	Surge not repetitive forward current $t_p = 10$ ms sinusoidal	120	A
$P_{TOT}$	Total dissipation at $T_C = 25$ °C	200	W
$T_{stg}$	Storage temperature	– 55 to 150	°C
$T_j$	Operating junction temperature		

1. Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{j(max)} - T_C}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_C(T_C))}$$

2. Pulse width limited by max junction temperature
3.  $V_{CLAMP} = 80\%$  ( $V_{CES}$ ),  $V_{GE} = 15$  V,  $R_G = 10 \Omega$ ,  $T_J = 150$  °C

**Table 3. Thermal resistance**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case IGBT max.	0.63	°C/W
	Thermal resistance junction-case diode max.	1.5	°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient max.	50	°C/W

## 2 Electrical characteristics

( $T_{CASE} = 25^\circ\text{C}$  unless otherwise specified)

**Table 4. Static electrical characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage ( $V_{GE} = 0$ )	$I_C = 1 \text{ mA}$	600			V
$V_{CE(\text{sat})}$	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_C = 20 \text{ A}$ $V_{GE} = 15 \text{ V}, I_C = 20 \text{ A}, T_C = 125^\circ\text{C}$		2.1 1.8	2.5	V V
$V_{GE(\text{th})}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250\mu\text{A}$	3.75		5.75	V
$I_{CES}$	Collector cut-off current ( $V_{GE} = 0$ )	$V_{CE} = 600 \text{ V}$ $V_{CE} = 600 \text{ V}, T_C = 125^\circ\text{C}$			250 1	$\mu\text{A}$ mA
$I_{GES}$	Gate-emitter leakage current ( $V_{CE} = 0$ )	$V_{GE} = \pm 20 \text{ V}$			$\pm 100$	nA
$g_{fs}$	Forward transconductance	$V_{CE} = 15 \text{ V}, I_C = 20 \text{ A}$		15		S

**Table 5. Dynamic electrical characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{ies}$	Input capacitance			2080		pF
$C_{oes}$	Output capacitance	$V_{CE} = 25 \text{ V}, f = 1 \text{ MHz}$ ,		175		pF
$C_{res}$	Reverse transfer capacitance	$V_{GE} = 0$		52		pF
$Q_g$	Total gate charge	$V_{CE} = 390 \text{ V}, I_C = 20 \text{ A}$ ,		102		nC
$Q_{ge}$	Gate-emitter charge	$V_{GE} = 15 \text{ V}$ ,		17.5		nC
$Q_{gc}$	Gate-collector charge	(see Figure 18)		47	140	nC

**Table 6. Switching on/off (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ $t_r$ ( $di/dt$ ) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}$ , $I_C = 20 \text{ A}$ $R_G = 10 \Omega$ , $V_{GE} = 15 \text{ V}$ , (see Figure 17)		29.5 12 1640		ns ns A/ $\mu\text{s}$
$t_{d(on)}$ $t_r$ ( $di/dt$ ) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}$ , $I_C = 20 \text{ A}$ $R_G = 10 \Omega$ , $V_{GE} = 15 \text{ V}$ , $T_C = 125^\circ\text{C}$ (see Figure 17)		29 13.5 1600		ns ns A/ $\mu\text{s}$
$t_r(V_{off})$ $t_d(off)$ $t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}$ , $I_C = 20 \text{ A}$ , $R_{GE} = 10 \Omega$ , $V_{GE} = 15 \text{ V}$ , (see Figure 17)		19.5 118 27		ns ns ns
$t_r(V_{off})$ $t_d(off)$ $t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}$ , $I_C = 20 \text{ A}$ , $R_{GE} = 10 \Omega$ , $V_{GE} = 15 \text{ V}$ , $T_C = 125^\circ\text{C}$ (see Figure 17)		46 151 38		ns ns ns

**Table 7. Switching energy (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$E_{on}^{(1)}$ $E_{off}$ $E_{ts}$	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}$ , $I_C = 20 \text{ A}$ $R_G = 10 \Omega$ , $V_{GE} = 15 \text{ V}$ , (see Figure 19)		305 181 486		$\mu\text{J}$ $\mu\text{J}$ $\mu\text{J}$
$E_{on}^{(1)}$ $E_{off}$ $E_{ts}$	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}$ , $I_C = 20 \text{ A}$ $R_G = 10 \Omega$ , $V_{GE} = 15 \text{ V}$ , $T_C = 125^\circ\text{C}$ (see Figure 19)		455 355 810		$\mu\text{J}$ $\mu\text{J}$ $\mu\text{J}$

1.  $E_{on}$  is the turn-on losses when a typical diode is used in the test circuit in Figure 19. If the IGBT is offered in a package with a co-pak diode, the co-pak diode is used as external diode. IGBTs & Diode are at the same temperature ( $25^\circ\text{C}$  and  $125^\circ\text{C}$ ).  $E_{on}$  include diode recovery energy.

**Table 8. Collector-emitter diode**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Unit</b>
$V_F$	Forward on-voltage	$I_F = 20 \text{ A}$ $I_F = 20 \text{ A}, T_C = 125^\circ\text{C}$		2.6 1.6		V V
$t_{rr}$ $Q_{rr}$ $I_{rrm}$	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 50 \text{ V},$ $\text{di/dt} = 100 \text{ A}/\mu\text{s}$ <i>(see Figure 20)</i>		40 50 2.5		ns nC A
$t_{rr}$ $Q_{rr}$ $I_{rrm}$	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 50 \text{ V},$ $T_C = 125^\circ\text{C}, \text{di/dt} = 100 \text{ A}/\mu\text{s}$ <i>(see Figure 20)</i>		80 180 4.5		ns nC A

## 2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

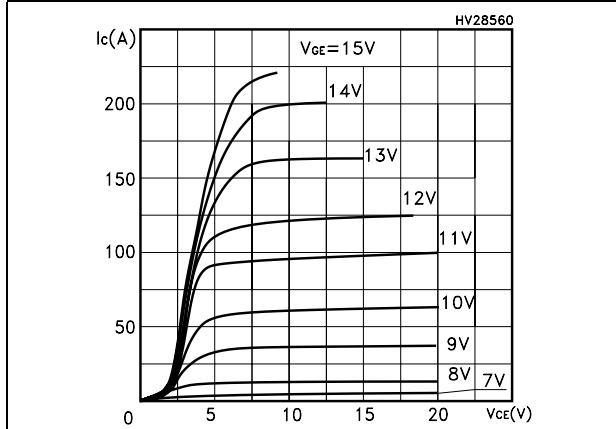


Figure 3. Transfer characteristics

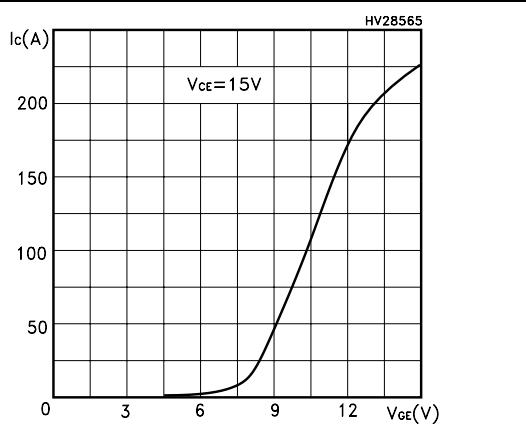


Figure 4. Transconductance

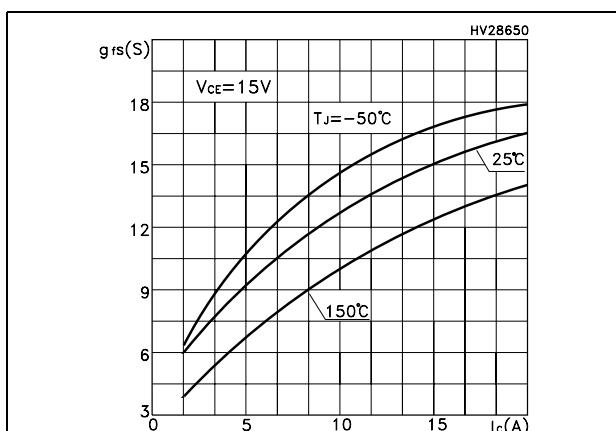


Figure 5. Collector-emitter on voltage vs temperature

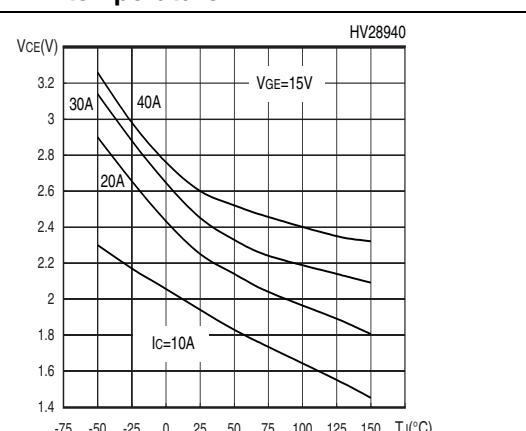
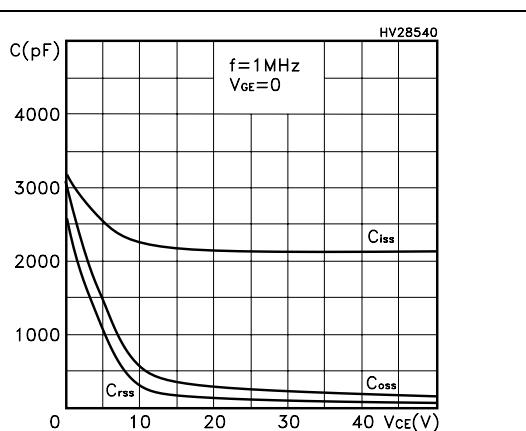
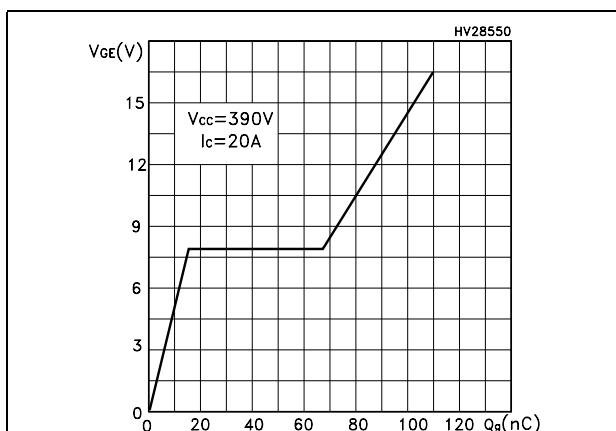
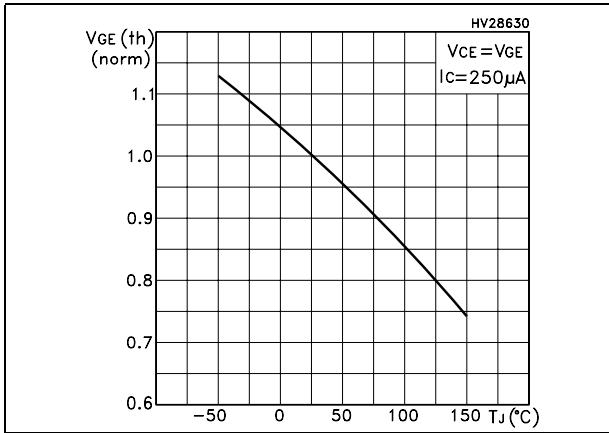
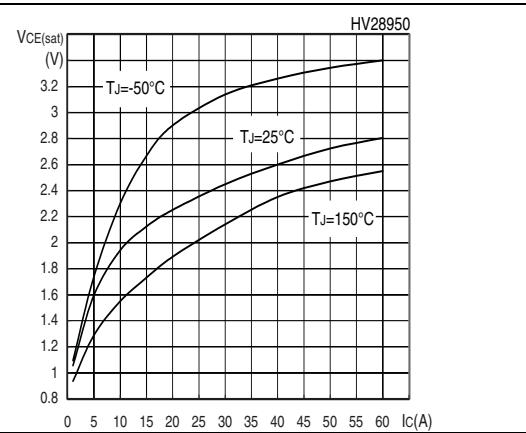
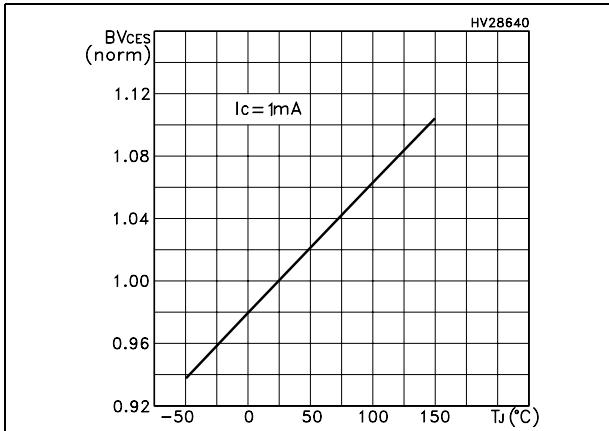
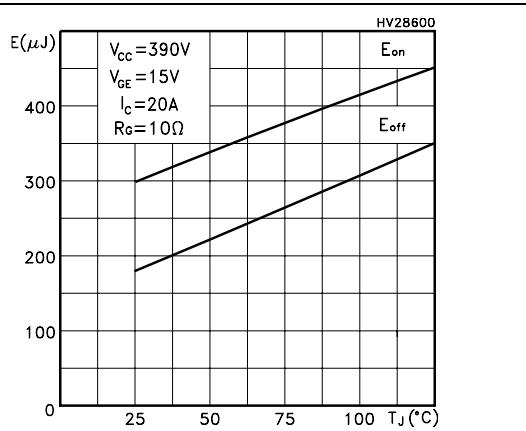
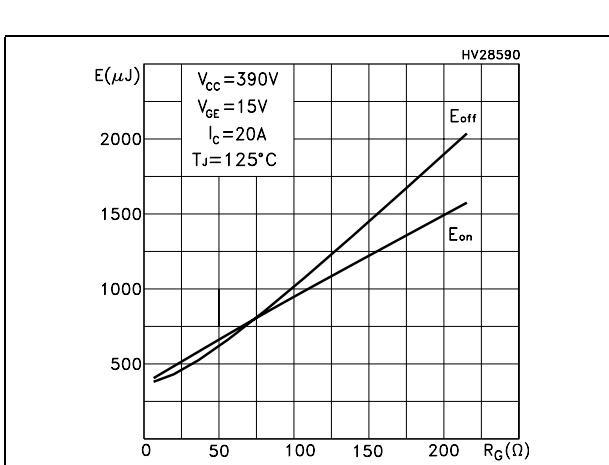
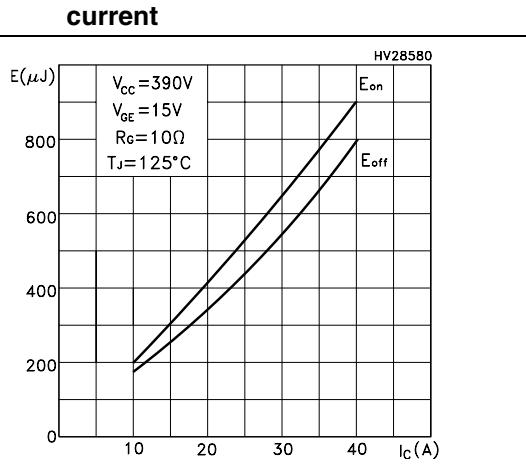
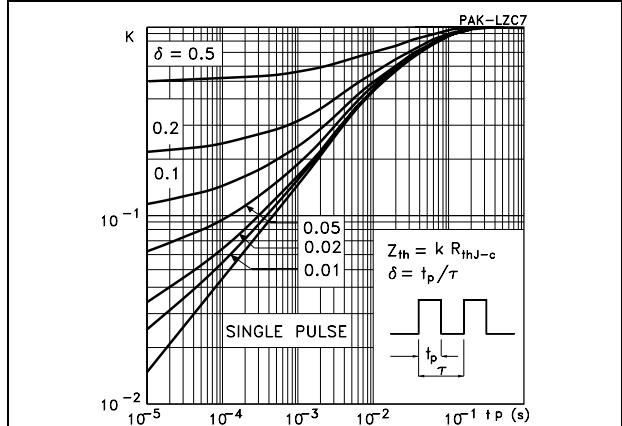
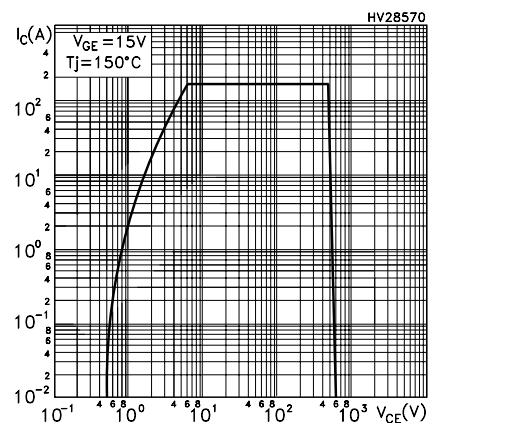
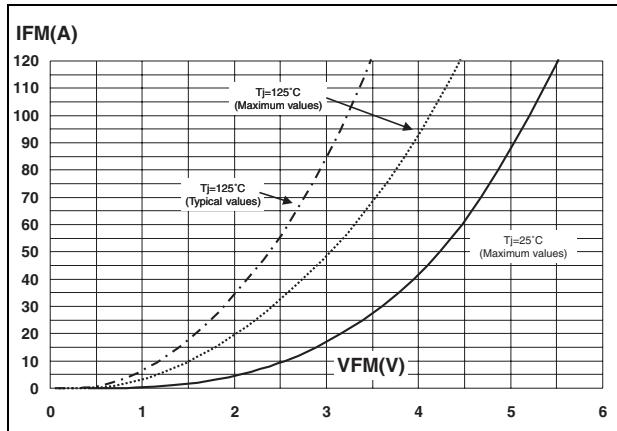


Figure 6. Gate charge vs gate-source voltage

Figure 7. Capacitance variations

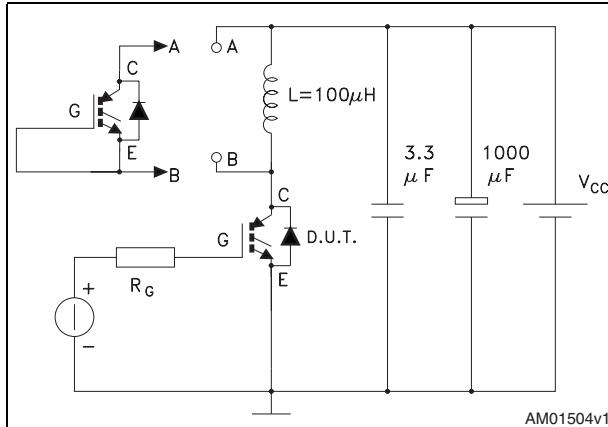


**Figure 8. Normalized gate threshold voltage vs temperature****Figure 9. Collector-emitter on voltage vs collector current****Figure 10. Normalized breakdown voltage vs temperature****Figure 11. Switching losses vs temperature****Figure 12. Switching losses vs gate resistance****Figure 13. Switching losses vs collector current**

**Figure 14. Thermal impedance****Figure 15. Turn-off SOA****Figure 16. Emitter-collector diode characteristics**

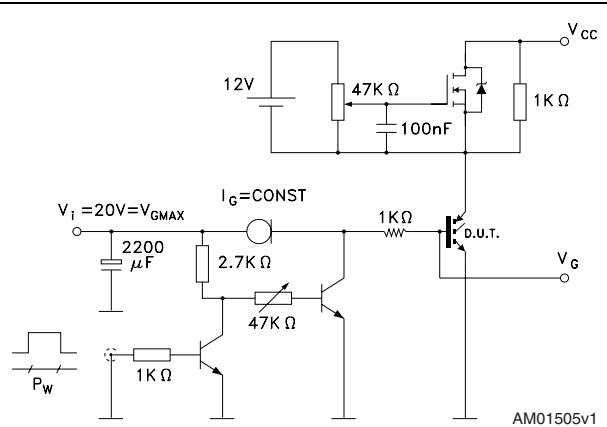
## 3 Test circuit

**Figure 17. Test circuit for inductive load switching**

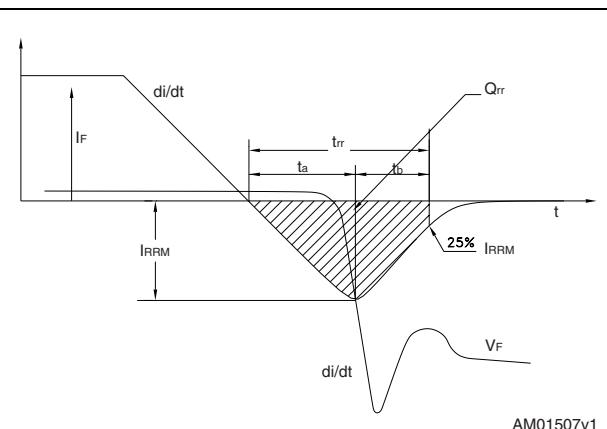
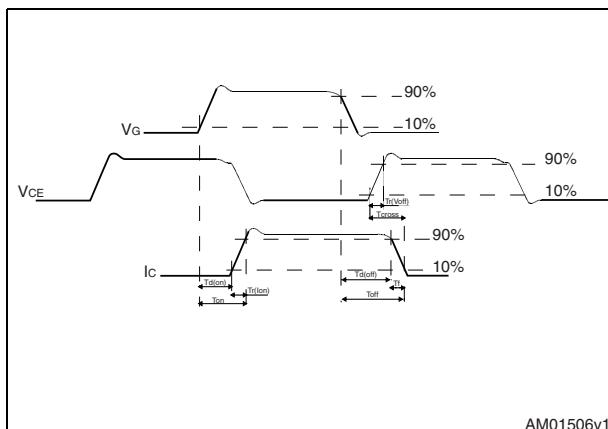


**Figure 19. Switching waveform**

**Figure 18. Gate charge test circuit**



**Figure 20. Diode recovery time waveform**

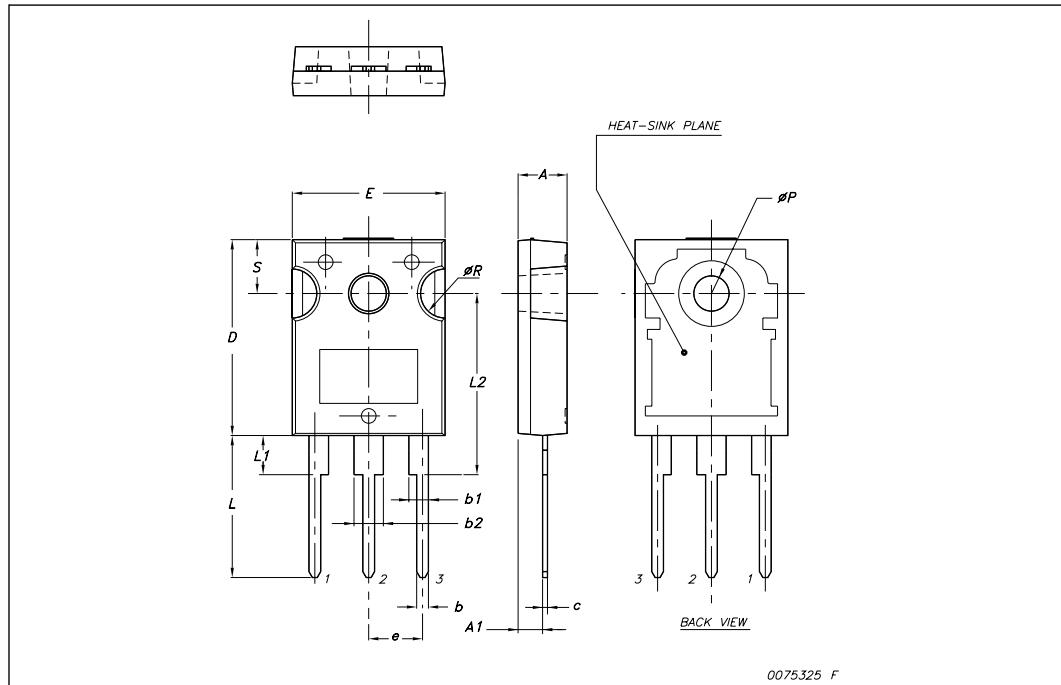


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com)

## TO-247 Mechanical data

Dim.	mm.		
	Min.	Typ	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
$\phi P$	3.55		3.65
$\phi R$	4.50		5.50
S		5.50	



## 5 Revision history

**Table 9. Document revision history**

Date	Revision	Changes
21-Nov-2005	1	Initial release.
29-Nov-2005	2	Modified <i>Figure 5</i> and <i>Figure 6</i>
06-Mar-2006	3	New template
12-Jul-2007	4	Corrected <i>Figure 11</i> , <i>Figure 12</i> , <i>Figure 13</i>
11-Nov-2008	5	<i>Figure 16</i> has been updated.